

**$V_{DRM}$**  = 1800 V  
 **$I_{T(AV)M}$**  = 3000 A  
 **$I_{T(RMS)}$**  = 4710 A  
 **$I_{TSM}$**  = 50.54×1 A  
 **$V_{TO}$**  = 0.88 V  
 **$r_T$**  = 0.103 mΩ

# Phase Control Thyristor

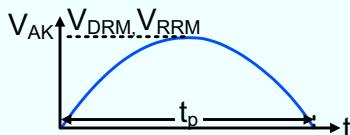
**5STP 27H1800**

Doc. No. 5SYA1048-03 May 07

- Patented free-floating silicon technology
- Low on-state and switching losses
- Designed for traction, energy and industrial applications
- Optimum power handling capability

## Blocking

Maximum rated values <sup>1)</sup>

Parameter	Symbol	Conditions	5STP 27H1800		Unit
Max repetitive peak forward and reverse blocking voltage	$V_{DRM}$ , $V_{RRM}$	$f = 50 \text{ Hz}$ , $t_p = 10 \text{ ms}$ , $T_{vj} = 5 \dots 125^\circ\text{C}$ , Note 1	1800		V
					
Critical rate of rise of commutating voltage	$dv/dt_{crit}$	Exp. to 1210 V, $T_{vj} = 125^\circ\text{C}$	1000		V/μs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Forward leakage current	$I_{DRM}$	$V_{DRM}$ , $T_{vj} = 125^\circ\text{C}$			200	mA
Reverse leakage current	$I_{RRM}$	$V_{RRM}$ , $T_{vj} = 125^\circ\text{C}$			200	mA

Note 1: Voltage de-rating factor of 0.11% per °C is applicable for  $T_{vj}$  below +5 °C

## Mechanical data

Maximum rated values <sup>1)</sup>

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	$F_M$		45	50	60	kN
Acceleration	a	Device unclamped			50	$\text{m/s}^2$
Acceleration	a	Device clamped			100	$\text{m/s}^2$

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Weight	m				0.9	kg
Housing thickness	H	$F_M = 50 \text{ kN}$ , $T_a = 25^\circ\text{C}$	25.6		26.3	mm
Surface creepage distance	$D_S$		36			mm
Air strike distance	$D_a$		15			mm

1) Maximum rated values indicate limits beyond which damage to the device may occur

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## On-state

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Average on-state current	$I_{T(AV)M}$	Half sine wave, $T_c = 70^\circ C$			3000	A
RMS on-state current	$I_{T(RMS)}$				4710	A
Peak non-repetitive surge current	$I_{TSM}$	$t_p = 10 \text{ ms}, T_{vj} = 125^\circ C, \text{sine wave}$ $\text{after surge: } V_D = V_R = 0 \text{ V}$			$50.54 \times 10^3$	A
Limiting load integral	$I^2t$				$12.8 \times 10^6$	$A^2\text{s}$
Peak non-repetitive surge current	$I_{TSM}$	$t_p = 8.3 \text{ ms}, T_{vj} = 125^\circ C, \text{sine wave}$ $\text{after surge: } V_D = V_R = 0 \text{ V}$			$53.3 \times 10^3$	A
Limiting load integral	$I^2t$				$11.8 \times 10^6$	$A^2\text{s}$

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	$V_T$	$I_T = 3000 \text{ A}, T_{vj} = 125^\circ C$			1.2	V
Threshold voltage	$V_{(TO)}$	$I_T = 2000 \text{ A} - 6000 \text{ A}, T_{vj} = 125^\circ C$			0.88	V
Slope resistance	$r_T$				0.103	$m\Omega$
Holding current	$I_H$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$			70	$mA$
Latching current	$I_L$				60	$mA$
		$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$			600	$mA$
					200	$mA$

## Switching

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Critical rate of rise of on-state current	$di/dt_{crit}$	$T_{vj} = 125^\circ C, I_T = I_{T(AV)}, f = 50 \text{ Hz}$			150	$A/\mu s$
Critical rate of rise of on-state current	$di/dt_{crit}$	$V_D \leq 1880 \text{ V}, I_{FG} = 2 \text{ A}, t_r = 0.5 \mu s$			1000	$A/\mu s$
Circuit-commutated turn-off time	$t_q$	$T_{vj} = 125^\circ C, I_{TRM} = 2000 \text{ A}, V_R = 200 \text{ V}, di_T/dt = -1.5 \text{ A}/\mu s, V_D \leq 0.67 \cdot V_{DRM}, dv_D/dt = 20 \text{ V}/\mu s$	400			$\mu s$

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Reverse recovery charge	$Q_{rr}$	$T_{vj} = 125^\circ C, I_{TRM} = 2000 \text{ A}, V_R = 200 \text{ V}, di_T/dt = -1.5 \text{ A}/\mu s$	400		1000	$\mu As$
Reverse recovery current	$I_{RM}$		15		40	A
Gate turn-on delay time	$t_{gd}$	$T_{vj} = 25^\circ C, V_D = 0.4 \cdot V_{RM}, I_{FG} = 2 \text{ A}, t_r = 0.5 \mu s$			3	$\mu s$

## Triggering

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Peak forward gate voltage	$V_{FGM}$				12	V
Peak forward gate current	$I_{FGM}$				10	A
Peak reverse gate voltage	$V_{RGM}$				10	V
Average gate power loss	$P_{G(AV)}$		see Fig. 9			W

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Gate-trigger voltage	$V_{GT}$	$T_{vj} = 25^\circ C$			2.6	V
Gate-trigger current	$I_{GT}$	$T_{vj} = 25^\circ C$			400	mA
Gate non-trigger voltage	$V_{GD}$	$V_D = 0.4 \times V_{DRM}, T_{vjmax} = 125^\circ C$	0.3			V
Gate non-trigger current	$I_{GD}$	$V_D = 0.4 \times V_{DRM}, T_{vjmax} = 125^\circ C$	10			mA

## Thermal

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Operating junction temperature range	$T_{vj}$				125	°C
Storage temperature range	$T_{stg}$		-40		140	°C

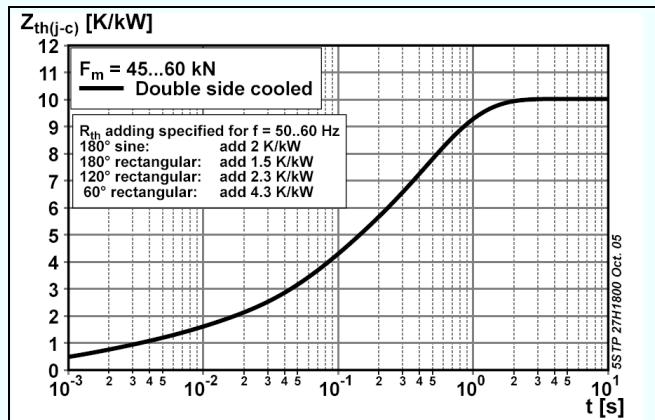
*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	$R_{th(j-c)}$	Double-side cooled $F_m = 45...60$ kN			10	K/kW
	$R_{th(j-c)A}$	Anode-side cooled $F_m = 45...60$ kN			20	K/kW
	$R_{th(j-c)C}$	Cathode-side cooled $F_m = 45...60$ kN			20	K/kW
Thermal resistance case to heatsink	$R_{th(c-h)}$	Double-side cooled $F_m = 45...60$ kN			2	K/kW
	$R_{th(c-h)}$	Single-side cooled $F_m = 45...60$ kN			4	K/kW

**Analytical function for transient thermal impedance:**

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

i	1	2	3	4
$R_i$ (K/kW)	6.640	2.128	0.755	0.500
$\tau_i$ (s)	0.4562	0.0593	0.0055	0.0011



**Fig. 1** Transient thermal impedance (junction-to-case) vs. time

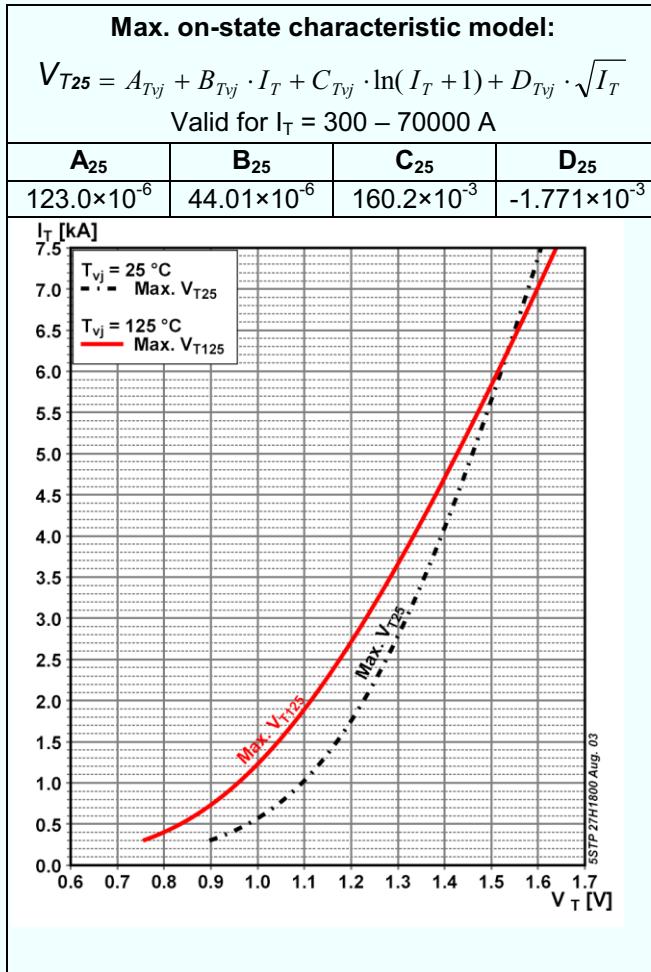


Fig. 2 On-state voltage characteristics

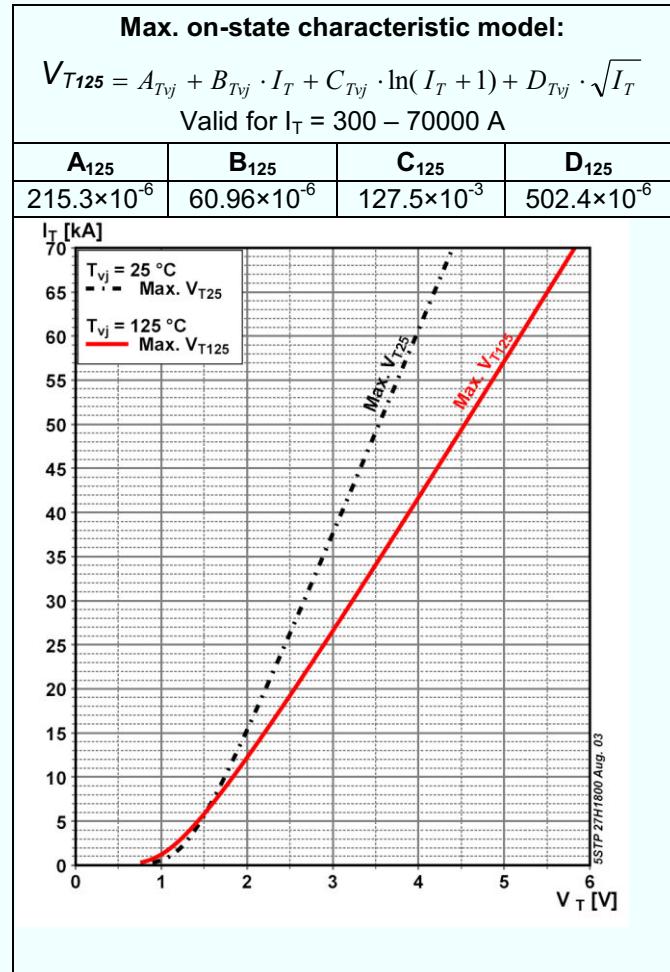
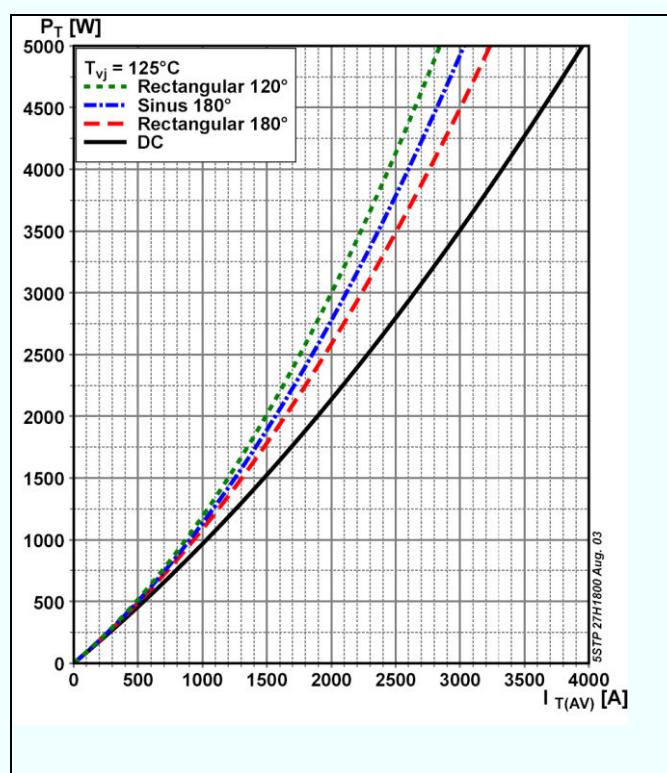
Fig. 3 On-state characteristics,  $T_j = 125^\circ\text{C}$ , 10ms half sine

Fig. 4 On-state power dissipation vs. mean on-state current, turn-on losses excluded

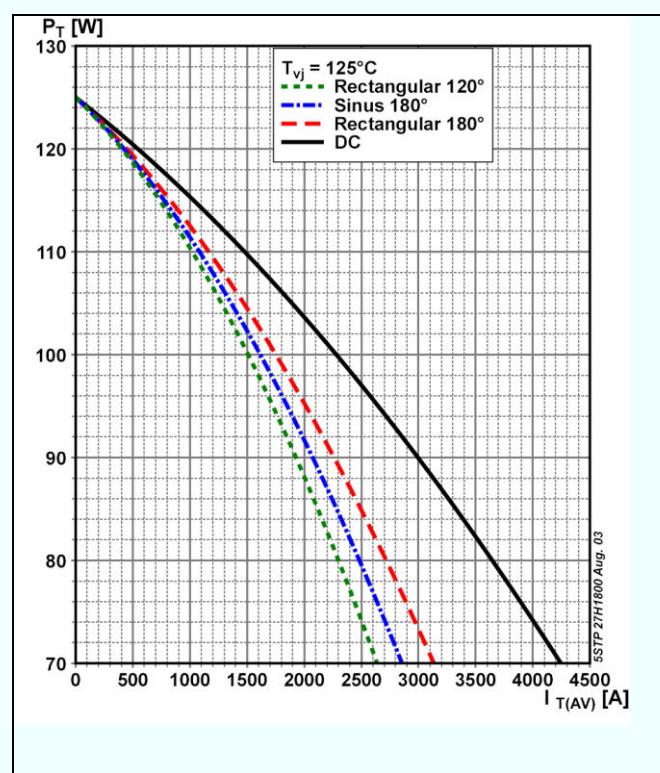
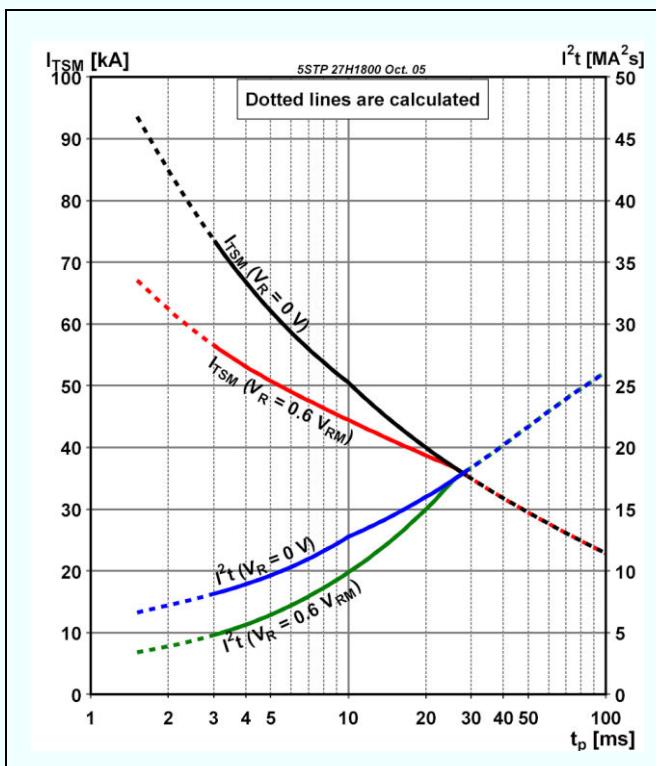
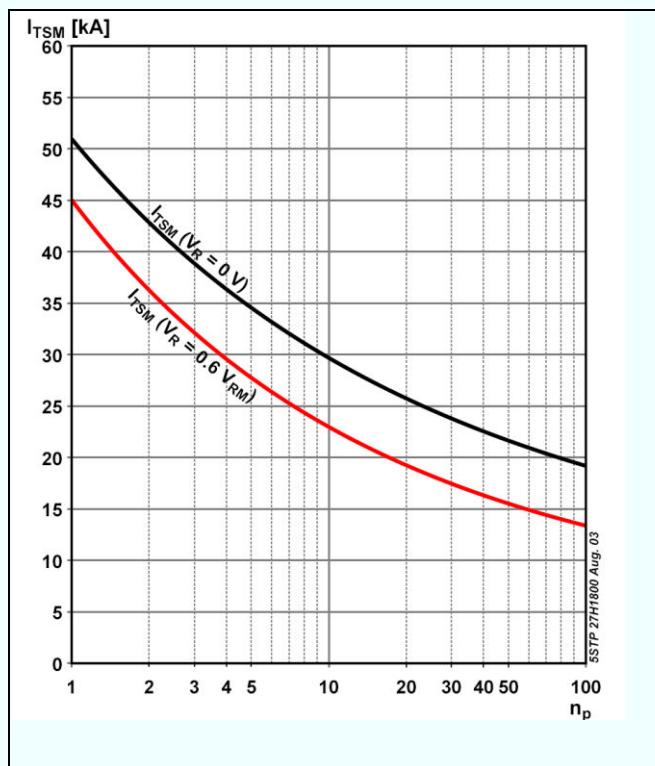


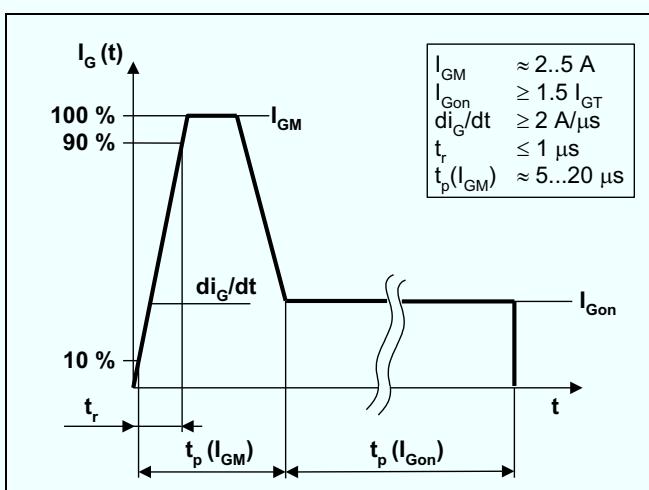
Fig. 5 Max. permissible case temperature vs. mean on-state current, switching losses ignored



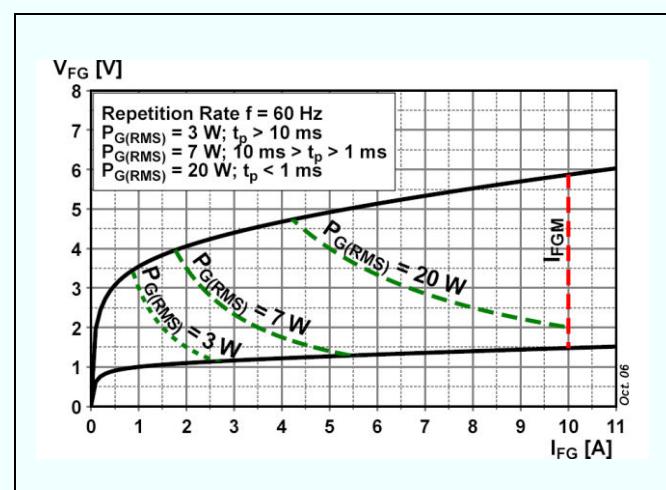
**Fig. 6** Surge on-state current vs. pulse length, half-sine wave



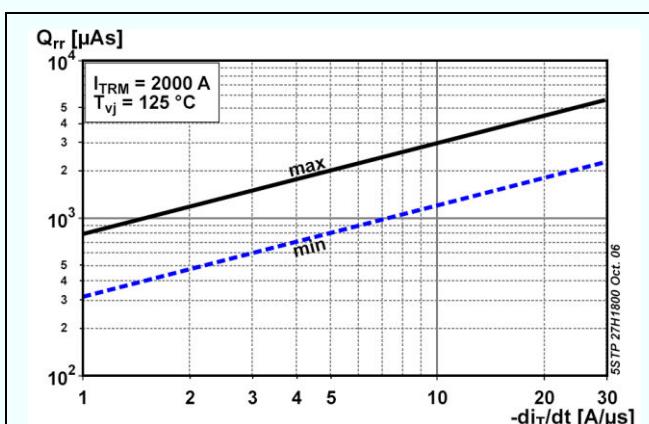
**Fig. 7** Surge on-state current vs. number of pulses, half-sine wave, 10 ms, 50Hz



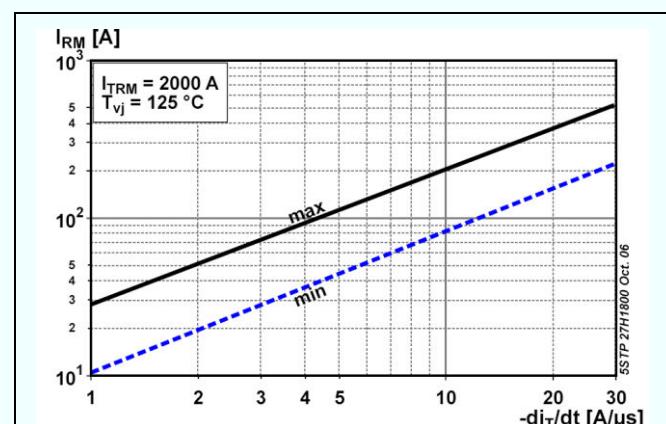
**Fig. 8** Recommended gate current waveform



**Fig. 9** Max. peak gate power loss



**Fig. 10** Reverse recovery charge vs. decay rate of on-state current



**Fig. 11** Peak reverse recovery current vs. decay rate of on-state current

## Turn-on and Turn-off losses

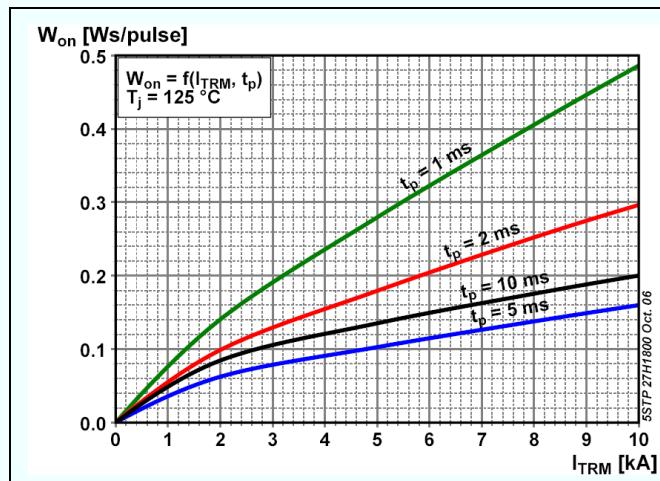


Fig. 12 Turn-on energy, half sinusoidal waves

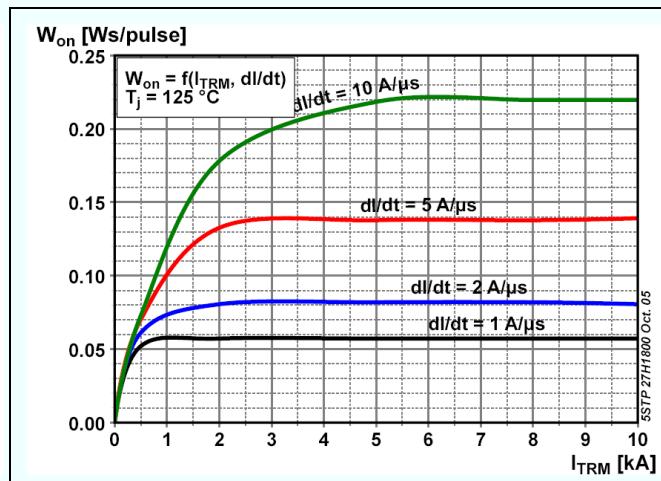


Fig. 13 Turn-on energy, rectangular waves

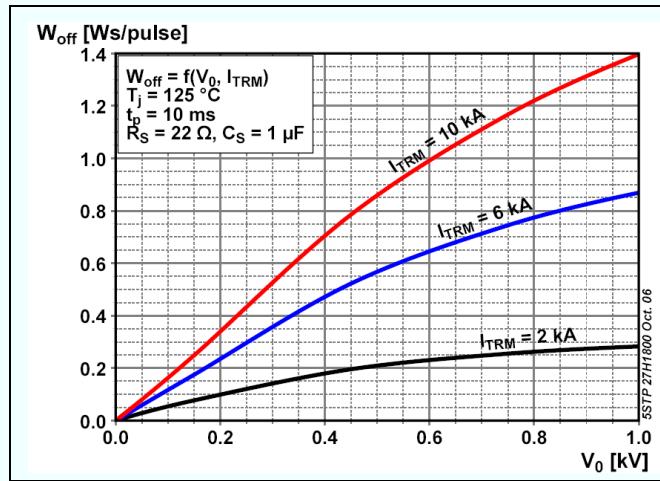


Fig. 14 Turn-off energy, half sinusoidal waves

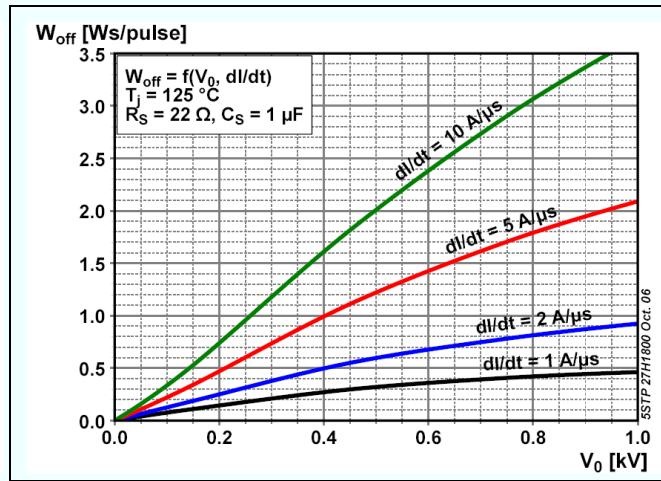


Fig. 15 Turn-off energy, rectangular waves

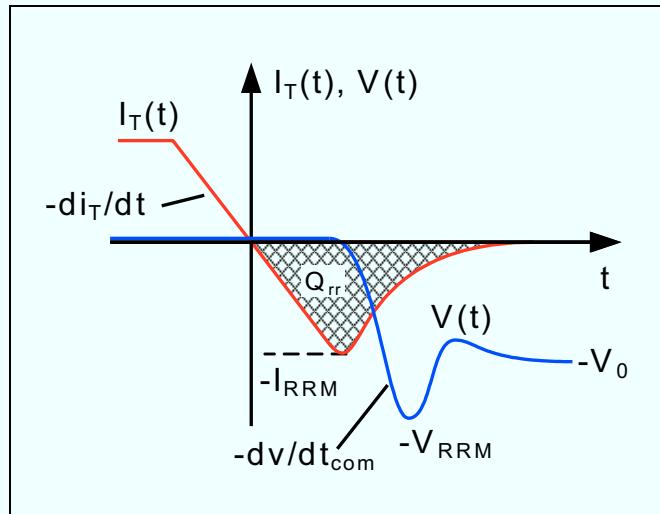


Fig. 16 Current and voltage waveforms at turn-off

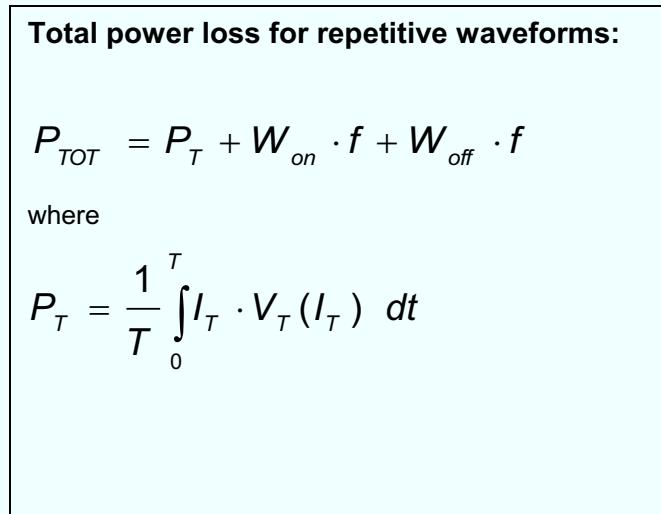
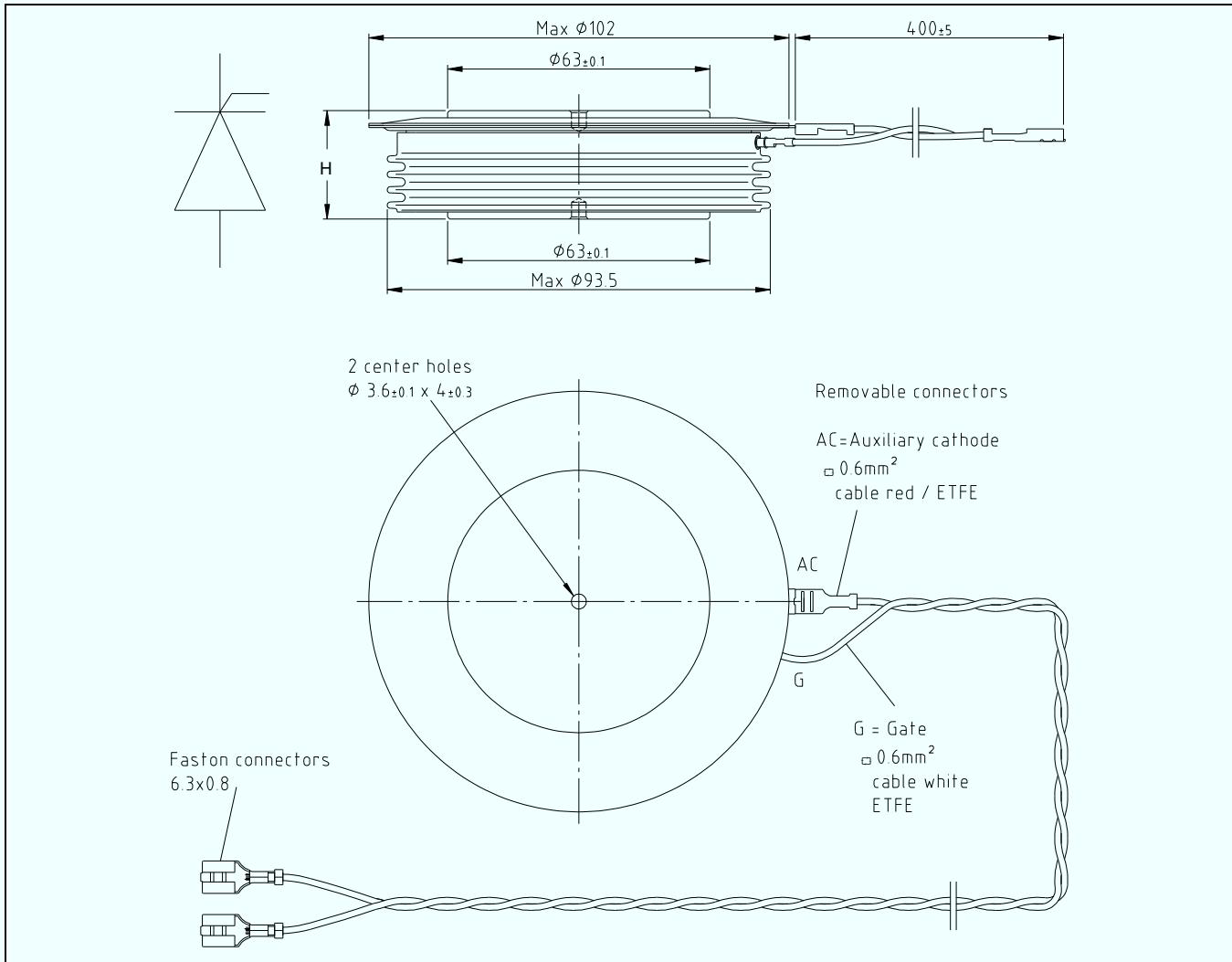


Fig. 17 Relationships for power loss



**Fig. 18** Device Outline Drawing

### Related documents:

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- |           |   |
|-----------|---|
| 5SYA 2020 | Design of RC-Snubber for Phase Control Applications   |
| 5SYA 2049 | Voltage definitions for phase control thyristors and diodes   |
| 5SYA 2051 | Voltage ratings of high power semiconductors  |
| 5SYA 2034 | Gate-Drive Recommendations for PCT's  |
| 5SYA 2036 | Recommendations regarding mechanical clamping of Press Pack High Power Semiconductors   |
| 5SZK 9104 | Specification of environmental class for pressure contact diodes, PCTs and GTO, STORAGE available on request, please contact factory        |
| 5SZK 9105 | Specification of environmental class for pressure contact diodes, PCTs and GTO, TRANSPORTATION available on request, please contact factory |

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